



## Surface Mounted Chip LED

Model No. : LS-SP192DNB74-D

## ■ Features :

- Compatible with automatic placement equipment
- Compatible with reflow solder process

## ■ Applications :

- Automotive\_Telecommunication
- Indicators
- LCD Back-lights
- Illuminations

|               |             |             |
|---------------|-------------|-------------|
| Dice Material | Light Color | Lens Color  |
| GaN           | Blue        | Water Clear |

## Absolute Maximum Ratings

( Ta=25°C )

| Item                                                     | Symbol           | Maximum    | Unit  |
|----------------------------------------------------------|------------------|------------|-------|
| Power Dissipation                                        | P <sub>D</sub>   | 100        | mW    |
| Continuous Forward Current                               | I <sub>F</sub>   | 25         | mA    |
| Peak Forward Current (1/10 Duty Cycle 0.1ms Pulse Width) | I <sub>FP</sub>  | 100        | mA    |
| Reverse Voltage                                          | V <sub>R</sub>   | 5          | V     |
| Derating Linear From 25°C                                |                  | 0.4        | mA/°C |
| Operating Temperature Range                              | T <sub>opr</sub> | -30 to +80 | °C    |
| Storage Temperature Range                                | T <sub>stg</sub> | -40 to +85 | °C    |

## Electrical / Optical Characteristics

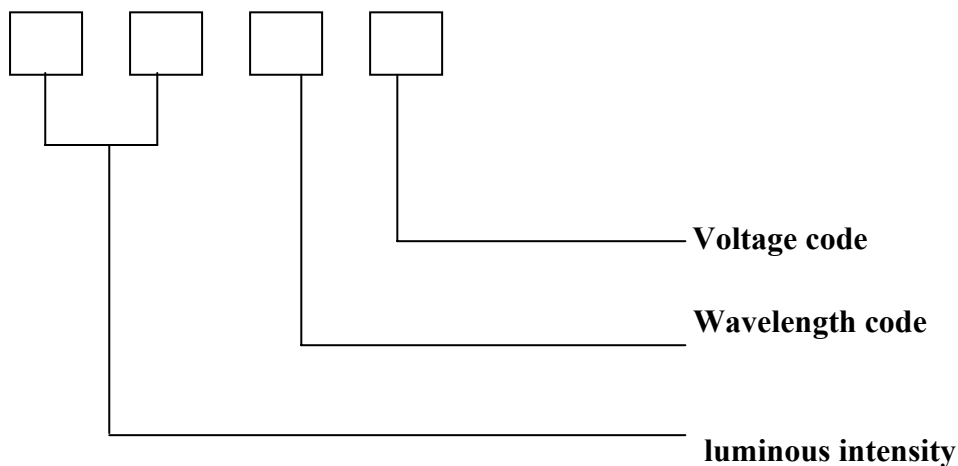
( Ta=25°C )

| Item                     | Symbol         | Condition           | Min. | Typ. | Max. | Unit |
|--------------------------|----------------|---------------------|------|------|------|------|
| Forward Voltage          | V <sub>F</sub> | I <sub>F</sub> =5mA |      | 2.90 | 3.20 | V    |
| Reverse Current          | I <sub>R</sub> | V <sub>R</sub> =5V  |      |      | 10   | uA   |
| Peak Emission Wavelength | λ <sub>P</sub> | I <sub>F</sub> =5mA |      | 468  |      | nm   |
| Dominant Wavelength      | λ <sub>D</sub> | I <sub>F</sub> =5mA |      | 470  |      | nm   |
| Viewing Angle            | 2 θ 1/2        | I <sub>F</sub> =5mA |      | 130  |      | Deg  |
| Luminous Intensity       | I <sub>V</sub> | I <sub>F</sub> =5mA | 7.2  |      |      | mcd  |

| ISSUE | DIMENSION NO : | VERSION : | DATE :     |
|-------|----------------|-----------|------------|
|       |                | A         | 2011/03/30 |
|       | APPROVAL :     | CHECK :   | EDIT :     |

## ◆ Packing coding principle

Notice: Bin code: luminous intensity / wavelength / voltage.



## ◆ The Luminous Intensity Grade of Blue Chip-LED Products

● Test Condition : @ 5mA

| Range,mcd | Bin code |
|-----------|----------|
| 7.2/9.0   | E1       |
| 9.0/11.5  | E2       |
| 11.5/14.5 | F1       |
| 14.5/18   | F2       |
| 18/22.5   | G1       |
| 22.5/28.5 | G2       |
| 28.5/36   | H1       |

## ◆ Dominant Wavelength Grade of Blue Chip-LED Products

● I type @ 5mA

| BIN | Range     | BIN | Range     |
|-----|-----------|-----|-----------|
| 0   | 461~463.5 | 4   | 471~473.5 |
| 1   | 463.5~466 | 5   | 473.5~476 |
| 2   | 466~468.5 | 6   | 476~478.5 |
| 3   | 468.5~471 | 7   | 478.5~481 |

## ◆ Forward Voltage Grade of Blue Chip-LED Products

● I type @ 5mA

| BIN | Range   | BIN | Range   |
|-----|---------|-----|---------|
| 1   | 2.6/2.7 | 4   | 2.9~3.0 |
| 2   | 2.7/2.8 | 5   | 3.0~3.1 |
| 3   | 2.8/2.9 | 6   | 3.1~3.2 |



### ◆ Descriptions :

- The Chip-LED Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature application, etc.

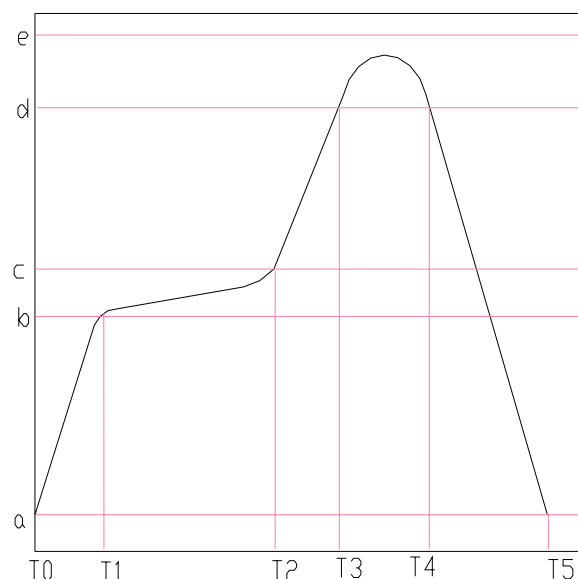
### ◆ Reliability Test Items And Conditions :

| NO. | Item                             | Test Conditions                                  | Test Hours / Cycle | Sample Q'ty | Ac / Re |
|-----|----------------------------------|--------------------------------------------------|--------------------|-------------|---------|
| 1   | Solder Heat                      | TEMP : 260°C±5°C                                 | 5 sec              | 36 pcs      | 0 / 1   |
| 2   | Temperature Cycle                | H : +100°C 30min.<br>∫ 5min.<br>L : -40°C 30min. | 50 cycle           | 36 pcs      | 0 / 1   |
| 3   | Thermal Shock                    | H : +100°C 5min.<br>∫ 10sec<br>L : -40°C 5min.   | 50 cycle           | 36 pcs      | 0 / 1   |
| 4   | High Temperature Storage         | TEMP : 100°C                                     | 1000 hrs           | 36 pcs      | 0 / 1   |
| 5   | Low Temperature Storage          | TEMP : -40°C                                     | 1000 hrs           | 36 pcs      | 0 / 1   |
| 6   | DC Operating Life                | I <sub>F</sub> = 20mA                            | 1000 hrs           | 36 pcs      | 0 / 1   |
| 7   | High Temperature / High Humidity | 85°C / 90~95%R.H.                                | 1000 hrs           | 36 pcs      | 0 / 1   |

### ◆ Reflow Temp. / Time : :

Please refer to the following figure :

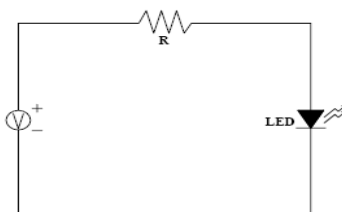
| Temp.(°C)  |     | Time(Sec)    |                |
|------------|-----|--------------|----------------|
| a          | 25  | T0~T1        | Max. 3°C/sec   |
| b          | 150 | T1~T2        | 90~130 sec     |
| c          | 200 | T2~T3        | Max. 3°C/sec   |
| d          | 220 | T3~T4        | Max. 30~50 sec |
| e          | 250 |              |                |
|            |     | T4~T5        | Max. -3°C/sec  |
| Blet Speed |     | 70~90 cm/min |                |



## ◆ Precautions For Use :

- Over – current – proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change ( Burn out will happen )



- Storage

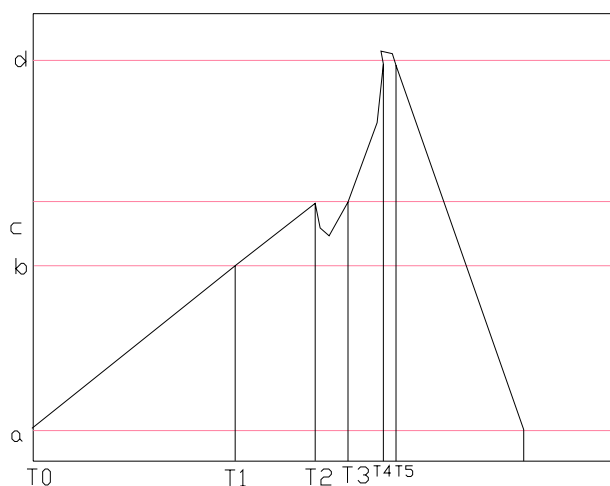
1. The operation of temperature and R.H. are :  $5^{\circ}\text{C} \sim 30^{\circ}\text{C}$  , R.H.60% Max..
2. Once the package is opened, the products should be used within 72 hrs. Otherwise, they should be kept in a dampproof box with desiccating regent. Considering the tape life, we suggest our customers to use our products within 1 year ( from production date ) .
3. It's recommended to bake before soldering when the package is unsealed after 72 hrs. The condition is :  $80^{\circ}\text{C} \pm 5^{\circ}\text{C}$  for 24hrs.

## ◆ Soldering Iron :

- Temperature at tip of iron :  $300^{\circ}\text{C}$  Max. ( 25W Max. )
- Soldering time :  $5 \pm 1\text{sec}$ .

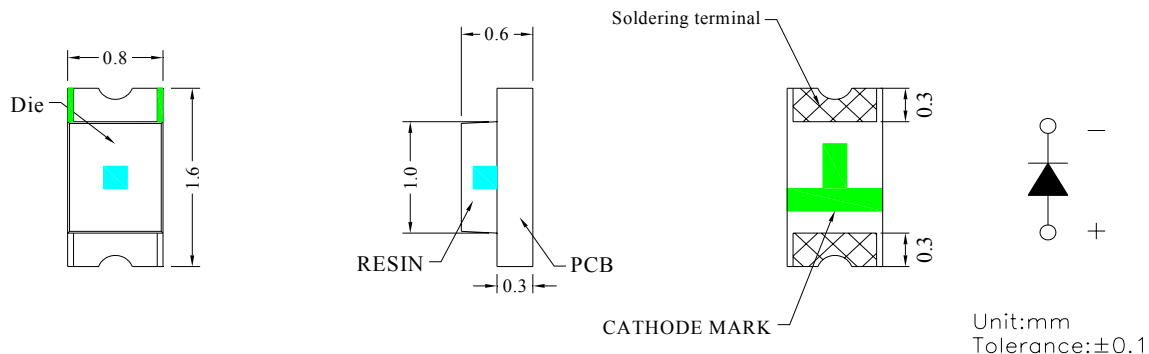
## ◆ Wave Soldering Temp. / Time :

| Temp.( $^{\circ}\text{C}$ ) |              | Time(Sec) |             |
|-----------------------------|--------------|-----------|-------------|
| a                           | 25           | T1~T2     | $60 \pm 20$ |
| b                           | $130 \pm 10$ | T2~T3     |             |
| c                           | 185          | T3~T6     |             |
| d                           | $250 \pm 3$  | T4~T5     | $3 \pm 2$   |
|                             |              |           |             |



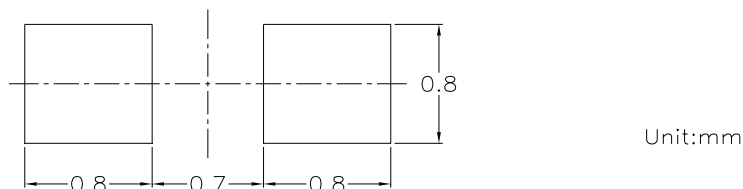


### ◆ Package Dimensions of Device ( LS-SP192 Series )



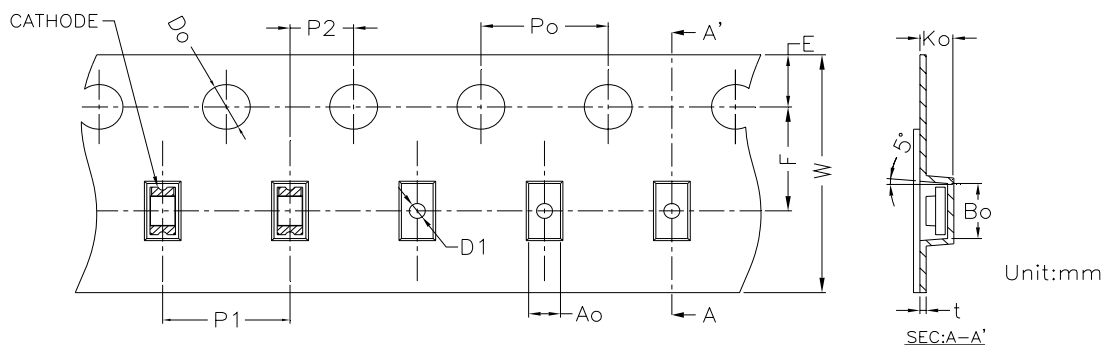
1. Soldering terminal may shift in x, y direction.

### ◆ Recommended Soldering Pad Dimensions

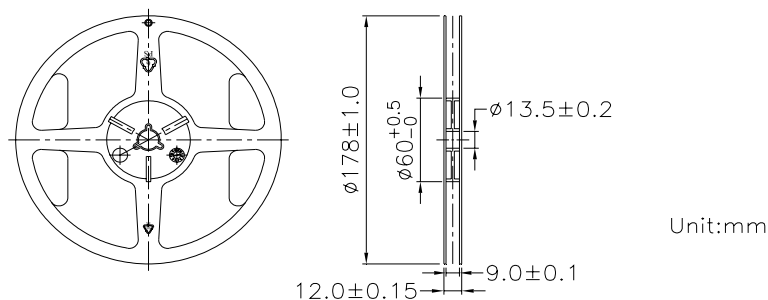


### ◆ Tape Specification : 4000pcs Per Reel

| Packing Size |       |       |       |       |                |       |       |       |       |       |       |       |       |
|--------------|-------|-------|-------|-------|----------------|-------|-------|-------|-------|-------|-------|-------|-------|
| Item         | W     | P1    | E     | F     | Do             | D1    | Po    | 10Po  | P2    | Ao    | Bo    | Ko    | t     |
| Spec.        | 8.00  | 4.00  | 1.75  | 3.50  | 1.50           | 0.5   | 4.00  | 40.00 | 2.00  | 0.95  | 1.80  | 0.60  | 0.20  |
| Tolerance    | ±0.20 | ±0.10 | ±0.10 | ±0.05 | +0.10<br>-0.00 | ±0.05 | ±0.05 | ±0.20 | ±0.05 | ±0.10 | ±0.10 | ±0.10 | ±0.05 |

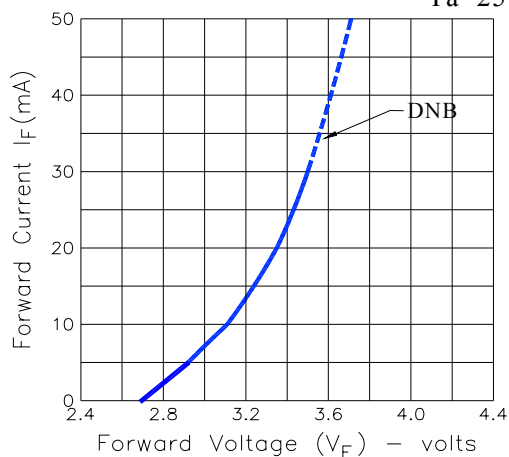


### ◆ Package Dimensions of Reel



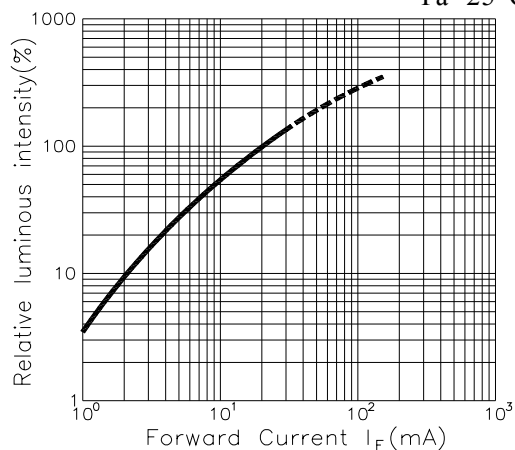
Forward Current Vs. Forward Voltage

$T_a = 25^\circ\text{C}$

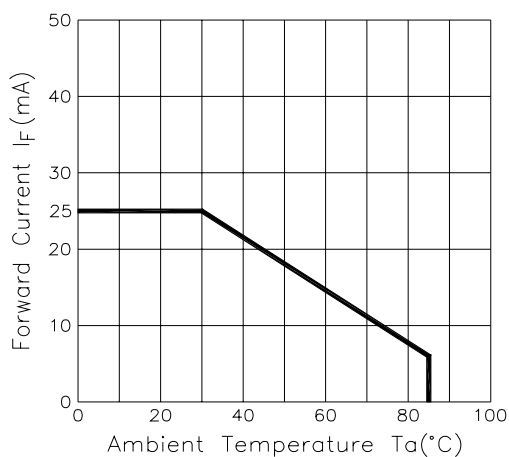


Luminous Intensity Vs. Forward Current

$T_a = 25^\circ\text{C}$

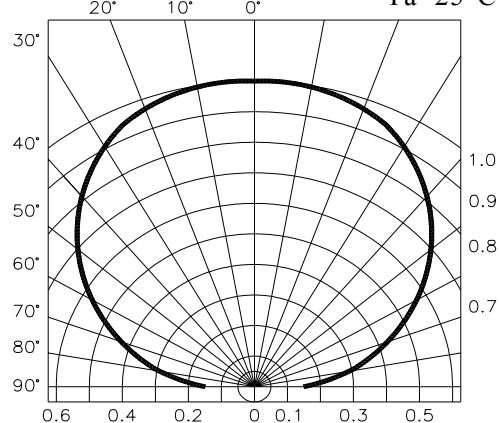


Forward Current Derating Curve



Radiation Diagram

$T_a = 25^\circ\text{C}$



Spectrum Distribution

